

#### microSDHC Card Features

# microSDHC Card

#### MTSD008AEC1MS-1WT

#### **Features**

- Micron<sup>®</sup> 3D MLC NAND Flash
- Form factor: 8-pad microSD memory card (11mm × 15mm)
- Density<sup>1</sup>: 8GB
- SD Physical Layer Specification version 3.01 compliant<sup>2</sup>
  - microSD Card Specification version 3.00<sup>3</sup>
  - SD memory card file system specification
  - Password protection of cards
  - Supports secure digital interface (SD) and serial peripheral interface (SPI)
- Performance
  - Refer to Performance and Capacity (page 6) for read and write speed
- Bus speed mode (theoretical transfer rate @x4 bits)
  - Default: 3.3V signaling up to 12.5 MB/s @25 MHz
  - High-speed: 3.3V signaling up to 25 MB/s @50 MHz
  - SDR12: UHS-I 1.8V signaling up to 12.5 MB/s @25 MHz
  - SDR25: UHS-I 1.8V signaling up to 25 MB/s @50
  - SDR50: UHS-I 1.8V signaling up to 50 MB/s @100
  - SDR104: UHS-I 1.8V signaling up to 104 MB/s @208 MHz
  - DDR50: UHS-I 1.8V signaling up to 50 MB/s @50 MHz (sampled on both clock edges)
- Integrated power-on reset, oscillator, voltage regula-tion, and voltage detection circuits
- Built-in features for defect and error management
  - BCH error correction code implemented
  - Global wear leveling
  - Bad block management
  - Sudden power-off (SPO) protection
- Operating voltage: 2.7-3.6V
- Temperature
  - Operating: -25°C to +85°C
  - Storage: -40°C to +85°C

- Standards compliance
  - RoHS
  - FCC
  - CE
  - **BSMI**
  - KC RRA
  - W.E.E.E.
  - VCCI
  - IC
- · Halogen-free

- Notes: 1. Actual usable capacity may vary. 1GB equals 1 billion bytes.
  - 2. SD Specifications, Part 1, Physical Layer Specification, version 3.01.
  - 3. SD Specifications, Part 1, microSD Card Specification, version 3.00.

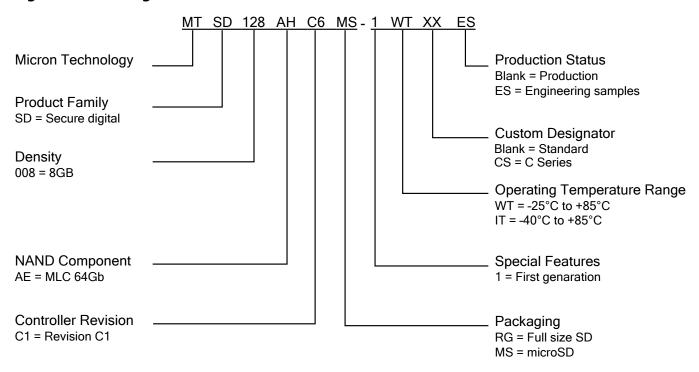


#### microSDHC Card Features

### **Part Number Ordering Information**

Micron microSD memory cards are available in different configurations and densities. Verify valid part numbers by using Micron's part catalog search at <a href="https://www.micron.com">www.micron.com</a>. To compare features and specifications by device type, visit <a href="https://www.micron.com/products">www.micron.com/products</a>. Contact the factory for cards not found.

**Figure 1: Marketing Part Number Chart** 



Note: 1. Not all combinations are necessarily available. For a list of available devices or for further information on any aspect of these products, please contact your nearest Micron sales office.

**Table 1: Ordering Information** 

Part Number	Capacity
MTSD008AEC1MS-1WT	8GB



### microSDHC Card Important Notes and Warnings

## **Important Notes and Warnings**

Micron Technology, Inc. ("Micron") reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions. This document supersedes and replaces all information supplied prior to the publication hereof. You may not rely on any information set forth in this document if you obtain the product described herein from any unauthorized distributor or other source not authorized by Micron.

Automotive Applications. Products are not designed or intended for use in automotive applications unless specifically designated by Micron as automotive-grade by their respective data sheets. Distributor and customer/distributor shall assume the sole risk and liability for and shall indemnify and hold Micron harmless against all claims, costs, damages, and expenses and reasonable attorneys' fees arising out of, directly or indirectly, any claim of product liability, personal injury, death, or property damage resulting directly or indirectly from any use of non-automotive-grade products in automotive applications. Customer/distributor shall ensure that the terms and conditions of sale between customer/distributor and any customer of distributor/customer (1) state that Micron products are not designed or intended for use in automotive applications unless specifically designated by Micron as automotive-grade by their respective data sheets and (2) require such customer of distributor/customer to indemnify and hold Micron harmless against all claims, costs, damages, and expenses and reasonable attorneys' fees arising out of, directly or indirectly, any claim of product liability, personal injury, death, or property damage resulting from any use of non-automotive-grade products in automotive applications.

Critical Applications. Products are not authorized for use in applications in which failure of the Micron component could result, directly or indirectly in death, personal injury, or severe property or environmental damage ("Critical Applications"). Customer must protect against death, personal injury, and severe property and environmental damage by incorporating safety design measures into customer's applications to ensure that failure of the Micron component will not result in such harms. Should customer or distributor purchase, use, or sell any Micron component for any critical application, customer and distributor shall indemnify and hold harmless Micron and its subsidiaries, subcontractors, and affiliates and the directors, officers, and employees of each against all claims, costs, damages, and expenses and reasonable attorneys' fees arising out of, directly or indirectly, any claim of product liability, personal injury, or death arising in any way out of such critical application, whether or not Micron or its subsidiaries, subcontractors, or affiliates were negligent in the design, manufacture, or warning of the Micron product.

Customer Responsibility. Customers are responsible for the design, manufacture, and operation of their systems, applications, and products using Micron products. ALL SEMICONDUCTOR PRODUCTS HAVE INHERENT FAIL-URE RATES AND LIMITED USEFUL LIVES. IT IS THE CUSTOMER'S SOLE RESPONSIBILITY TO DETERMINE WHETHER THE MICRON PRODUCT IS SUITABLE AND FIT FOR THE CUSTOMER'S SYSTEM, APPLICATION, OR PRODUCT. Customers must ensure that adequate design, manufacturing, and operating safeguards are included in customer's applications and products to eliminate the risk that personal injury, death, or severe property or environmental damages will result from failure of any semiconductor component.

Limited Warranty. In no event shall Micron be liable for any indirect, incidental, punitive, special or consequential damages (including without limitation lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort, warranty, breach of contract or other legal theory, unless explicitly stated in a written agreement executed by Micron's duly authorized representative.



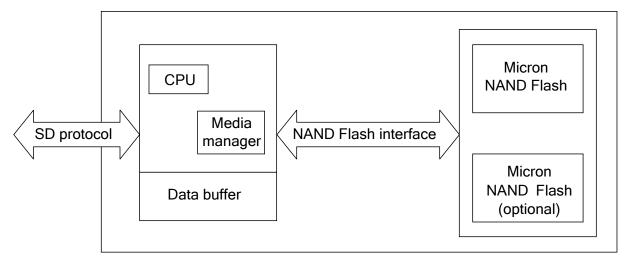
### microSDHC Card General Description

## **General Description**

The microSD card is an advanced Micron® 3D NAND Flash memory technology based removable storage device specifically designed to meet the performance, capacity, and quality required for mass market devices or systems. In addition to mass storage-specific Flash memory, the microSD card includes an on-board intelligent controller which manages interface protocols, security algorithms for content protection, data storage and retrieval, as well as error correction code (ECC) algorithms, defect handling, sudden power-off safeguard and wear leveling.

The microSD card includes one or more NAND Flash memory components and a microSD card controller. The density of a card depends on the number of die within the package and the density of each die.

**Figure 2: Functional Block Diagram** 



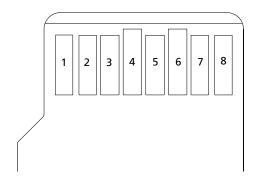
Note: 1. Not drawn to scale.



### microSDHC Card Pad Assignment and Descriptions

## **Pad Assignment and Descriptions**

Figure 3: microSD Card Pad Assignment (Bottom View)



**Table 2: MicroSD Contact Pad Description** 

Pad #		SD Mode	SPI Mode			
Pau #	Symbol Type <sup>1</sup> Description		Description	Symbol	Type <sup>1</sup>	Description
1	DAT2 <sup>2</sup>	I/O/PP	Data line [Bit 2]	RSV	_	Reserved
2	CD/DAT3 <sup>2</sup>	I/O/PP <sup>3</sup>	Card detect/data line [Bit 3]	CS	l <sub>3</sub>	Chip select (active low)
3	CMD	PP	Command/response	DI	I	Data in
4	$V_{DD}$	S	Supply voltage	$V_{DD}$	S	Supply voltage
5	CLK	I	Clock	SCLK	I	Clock
6	$V_{SS}$	S	Supply voltage ground	V <sub>SS</sub>	S	Supply voltage ground
7	DAT0	I/O/PP	Data line [Bit 0]	DO	O/PP	Data out
8	DAT1 <sup>2</sup>	I/O/PP	Data line [Bit 1]	RSV	-	Reserved

- Notes: 1. S: power supply; I: input; O: output using push-pull drivers; PP: I/O using push-pull driv-
  - 2. The extended DAT lines (DAT1-DAT3) are input on power-up. They start to operate as DAT lines after SET\_BUS\_WIDTH (ACMD6) command. The host shall keep its own DAT1-DAT3 lines in input mode, as well, while they are not used.
  - 3. After power-up, pad 2 is configured as an input with an internal  $50k\Omega$  pull-up (for card detection and SPI mode selection). The pull-up should be disconnected prior to regular data transfer by issuing the SET\_CLR\_CARD\_DETECT (ACMD42) command.



### microSDHC Card Performance and Capacity

## **Performance and Capacity**

#### **Performance**

The microSD cards also use performance features of the underlying NAND Flash to in-crease speed in streaming applications. By sending larger packets of sequential data, the microSD card can better utilize NAND Flash features to enhance performance.

Table 3: Measured Performance (25°C, V<sub>DD</sub> = 3.3V)

Density <sup>1</sup>	Sequential Read <sup>2</sup>	Sequential Write <sup>2</sup>
8GB	50 MB/s	24 MB/s

- Notes: 1. 1GB = 1 billion bytes.
  - 2. Measurements are based on a 256MB file size in UHS-I mode and depend on the host configuration used to run the test.

### **Capacity**

When quoting device capacity, Micron uses the formatted capacity, not the raw number of bytes available.

Table 4: Bytes Available After Factory Formatting (FAT32 for SDHC card and exFAT for SDXC card)

Density <sup>1</sup>	Density <sup>1</sup> Usable Bytes <sup>2</sup> Speed Class	
8GB	8,061,452,288	Class10, U1

- Notes: 1. 1GB = 1 billion bytes.
  - 2. Actual user usable capacity. When cloning disk partitions, the master disk should always be formatted to no more than the minimum guaranteed usable bytes available for that card capacity.
  - 3. Class is determined by Testmetrix VTE4100 Compliance Test.
  - 4. Enable users to run their smartphone apps from the installed memory card.



#### microSDHC Card Electrical Specifications

## **Electrical Specifications**

## **Absolute Ratings and Operating Conditions**

Stresses greater than those listed in may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions outside those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may adversely affect reliability.

**Table 5: Absolute Maximum Ratings** 

Parameter/Condition	Min	Max	Unit
V <sub>DD</sub> supply voltage	2.7	3.6	V
Storage temperature	-40	+85	°C

#### **Table 6: Recommended Operating Conditions**

Parameter/Condition	Symbol	Min	Тур	Max	Unit
Operating temperature	T <sub>A</sub>	-25	_	+85	°C
Supply voltage	V <sub>DD</sub>	2.7	3.3	3.6	V
Regulator supply voltage for 1.8V signaling	V <sub>DDIO</sub>	1.7	1.8	1.95	V
Ground supply voltage	V <sub>SS</sub>	0	0	0	V

#### **DC Characteristics**

#### **Table 7: DC Voltage Characteristics for 3.3V signaling**

Parameter	Symbol	Min	Мах	Unit	Comments
Input low voltage	$V_{IL}$	V <sub>ss</sub> - 0.30	$0.25 \times V_{DD}$	V	
Input high voltage	V <sub>IH</sub>	$0.625 \times V_{DD}$	$V_{DD} + 0.30$	V	
Output low voltage	V <sub>OL</sub>	_	$0.125 \times V_{DD}$	V	I <sub>OL</sub> = 2mA @ V <sub>DD</sub> (MIN)
Output high voltage	V <sub>OH</sub>	0.75 × V <sub>DD</sub>	_	V	$I_{OH} = -2mA @ V_{DD} (MIN)$

#### **Table 8: DC Voltage Characteristics for 1.8V signaling**

Parameter	Symbol	Min <sup>1</sup>	Max <sup>1</sup>	Unit	Comments
Input low voltage	V <sub>IL</sub>	V <sub>ss</sub> - 0.30	0.58	V	
Input high voltage	V <sub>IH</sub>	1.27	2.00	V	
Output low voltage	V <sub>OL</sub>	-	0.45	V	I <sub>OL</sub> = 2mA
Output high voltage	V <sub>OH</sub>	1.40	_	V	I <sub>OH</sub> = -2mA

Note: 1. As signaling level is generated by regulator in host and card, some of the values are defined by fixed value rather than based on V<sub>DD</sub>.



## microSDHC Card Electrical Specifications

#### **AC Characteristics**

Timing specifications including clock timing, input and output timings for all bus modes are defined in SD Specifications. Refer to Section 6.6 and 6.7 of Part 1, Physical Layer Specification, version 5.10 for detail information.

## **Electrostatic Discharge (ESD)**

Contacts pads:

• Human body model of ±4kV according to IEC61000-4-2.

Non contacts pad area:

- Coupling plane discharge of ±8kV.
- Air discharge of ±15kV.
- Human body model according to IEC61000-4-2.



## microSDHC Card Command Set

### **Command Set**

The SD specification categorizes commands into classes. Table 9 shows commands supported by the microSD card.

**Table 9: Supported Commands** 

Command Type	Card Command Class (CCC)	Supported Commands
Basic commands	Class 0	CMD0, CMD2, CMD3, CMD7, CMD8, CMD9, CMD10, CMD11, CMD12, CMD13, CMD15
Block-oriented read commands	Class 2	CMD16, CMD17, CMD18, CMD19, CMD20, CMD23
Block-oriented write commands	Class 4	CMD16, CMD20, CMD23, CMD24, CMD25, CMD27
Erase commands	Class 5	CMD32, CMD33, CMD38
Lock card	Class 7	CMD16, CMD42
Application-specific commands <sup>1</sup>	Class 8	CMD55, CMD56, ACMD6, ACMD13, ACMD22, ACMD23, ACMD41, ACMD42, ACMD51
Switch commands	Class 10	CMD6

Note: 1. Each application-specific (ACMD) command is a 2-sequence command. First, a CMD55 is sent, followed by a CMDx, where x is the ACMDx value.

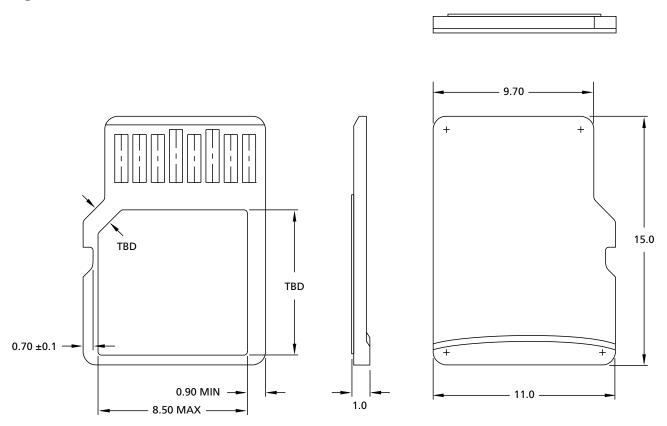


## microSDHC Card Package Dimensions

## **Package Dimensions**

Figure 4 provides the physical dimensions of Micron microSD card. For detail dimensions and tolerances, refer to SDA microSD Card Addendum, Section 3.0 Mechanical Specification for microSD Memory Card.

Figure 4: microSD Card - 11mm × 15mm



Note: 1. Dimensions are in millimeters.

**Table 10: Package Specifications** 

Parameter	Descriptions
Surface	Plain (except contact area)
Edges	Smooth edges
Weight	0.25gm



#### microSDHC Card Compliance

## **Compliance**

Micron microSD card comply with the following:

- · Micron Green Standard
- CE (Europe): EN 55032 Class B, RoHS
- FCC: CFR Title 47, Part 15 Class B
- BSMI (Taiwan): approval to CNS 13438 Class B and CNS 15663



• KC RRA (Korea): approval to KN32 Class B, KN 35 Class B

B 급 기기 이 기기는 가정용으로 전자파적합등록을한 기기로서 주거 (가정용 정보통신기기) 지역에서는 물론 모든지역에서 사용할 수 있습니다.



#### R-R-MU2-MTSDXXXAEC1MS

- W.E.E.E.: compliance with EU WEEE directive 2012/19/EC. Additional obligations
  may apply to customers who place these products in the markets where WEEE is enforced.
- VCCI (Japan): 2015-04 Class B

この装置は、クラス B 情報技術装置です。この装置は、家庭環境で使用することを目的としていますが、この装置がラジオやテレビジョン受信機に近接して使用されると、受信障害を引き起こすことがあります。 取扱説明書に従って正しい取り扱いをして下さい。

VCCI-B

- IC (Canada): ICES-003 Class B
  - This Class B digital apparatus complies with Canadian ICES-003.
  - Cet appareil numérique de la classe B est conforme à la norme NMB-003 du Canada.
  - CAN ICES-3 (B)/NMB-3(B).

#### **FCC Rules**

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

Reorient or relocate the receiving antenna.

### Micron Confidential and Proprietary



## microSDHC Card Compliance

- Increase the separation between the equipment and the receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.



## microSDHC Card Revision History

## **Revision History**

Rev. B - 6/19

• Updated Features Section

Rev. A - 3/19

· Initial version

8000 S. Federal Way, P.O. Box 6, Boise, ID 83707-0006, Tel: 208-368-4000 www.micron.com/products/support Sales inquiries: 800-932-4992 Micron and the Micron logo are trademarks of Micron Technology, Inc. All other trademarks are the property of their respective owners.

This data sheet contains minimum and maximum limits specified over the power supply and temperature range set forth herein. Although considered final, these specifications are subject to change, as further product development and data characterization sometimes occur.